



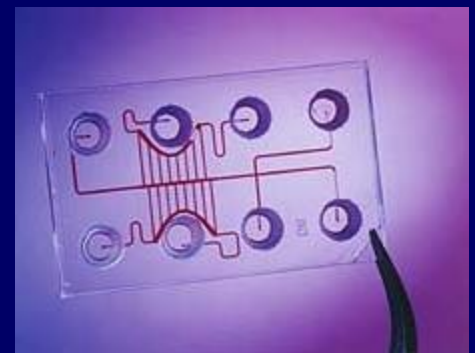
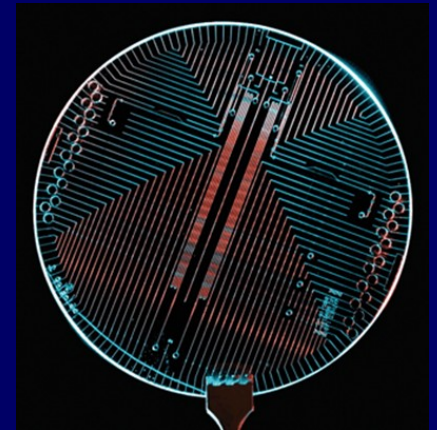
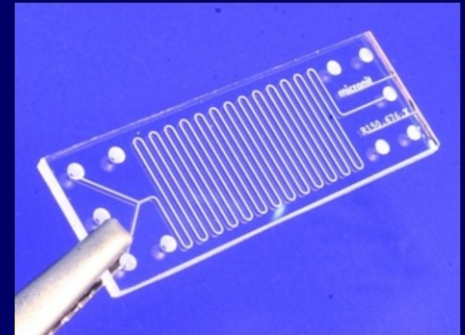
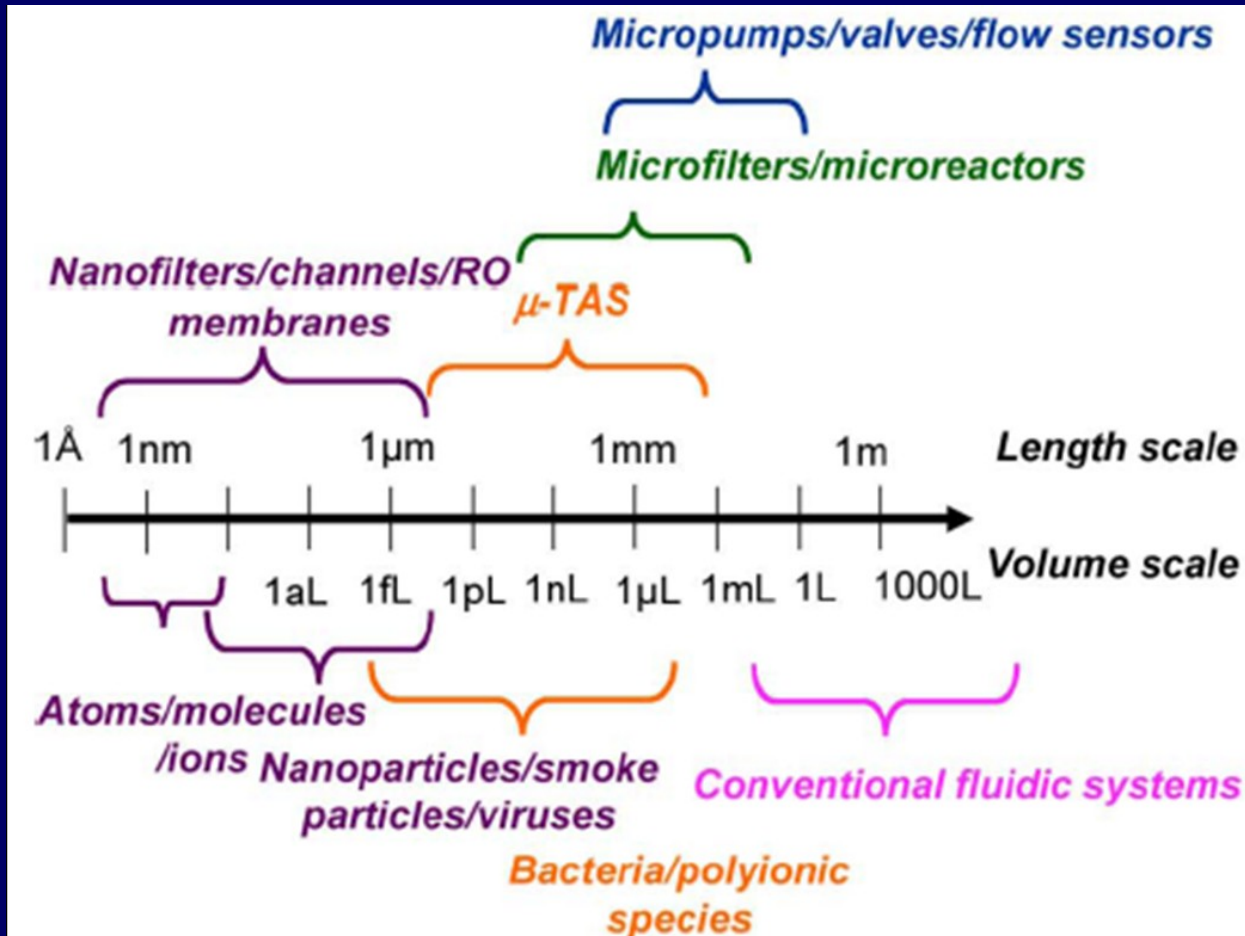
Tooling for Injection Molded Micro and Nanoscale Features

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Center for High-Rate Nanomanufacturing
University of Massachusetts Lowell

Devices Containing Small Features

Micro and nanofluidic devices



Possible Manufacturing Technologies

| | Hot Embossing | Nanoimprint | Injection Molding |
|----------------------|----------------------------|------------------------------|------------------------------|
| Materials | thermoplastics | thermoplastics or thermosets | thermoplastics or thermosets |
| Pressure | > 10 MPa | < 0.1 MPa | > 50 MPa |
| Temperature | > T_g | ~25°C | 150-400°C |
| Cycle time | 1-10 min. | 2 min. | 3-14 s |
| Minimum Feature Size | 50 nm high aspect ratio | < 157 nm low aspect ratio | Depends on tooling |

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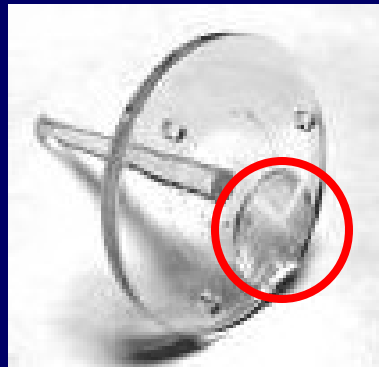
Injection molding can provide high-rate manufacturing of a wide range of materials

Approach: Injection Molding



injection molding machine

mold



molded part

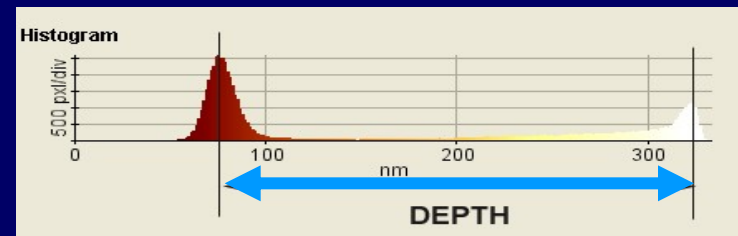
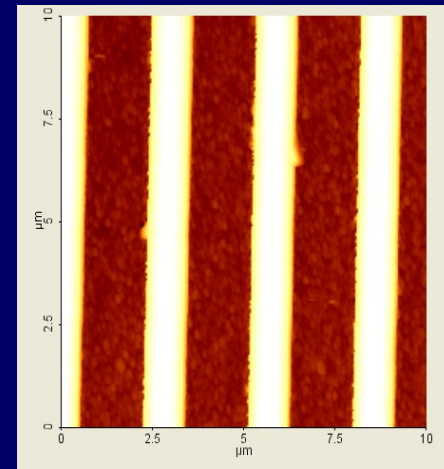
Quantifying Replication

■ Feature definition



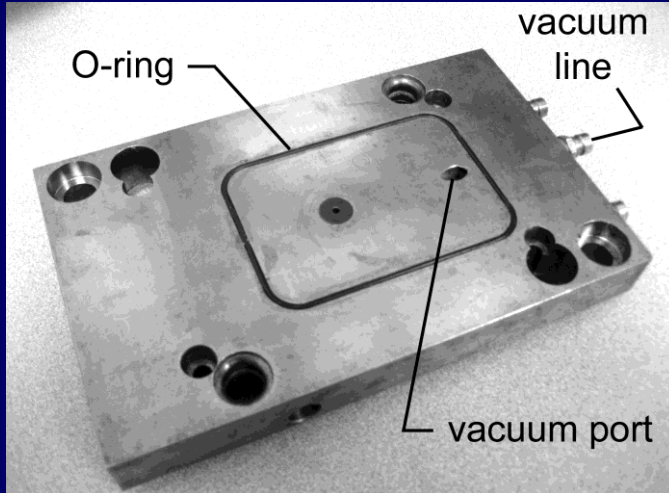
■ Depth ratio

$$DR = \frac{D_{part}}{D_{tool}}$$

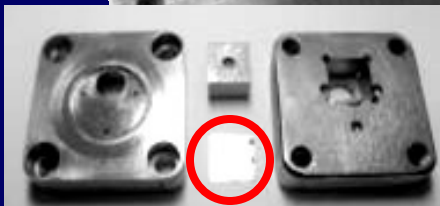
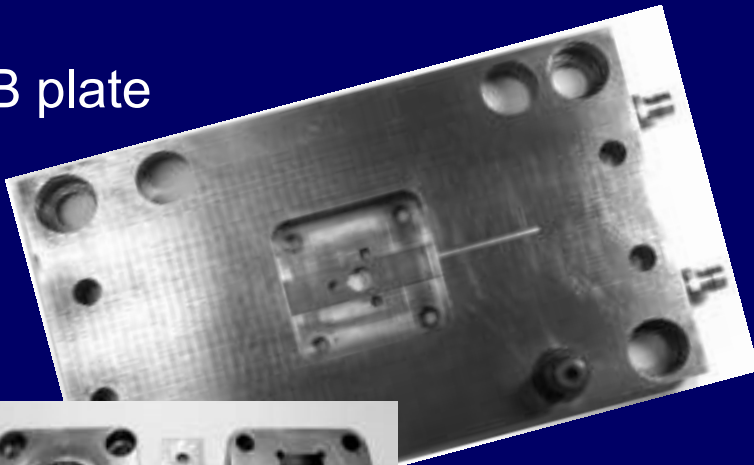


Inj. Molding: It's All About the Tooling

A plate



B plate



Insert & cartridge

Factors

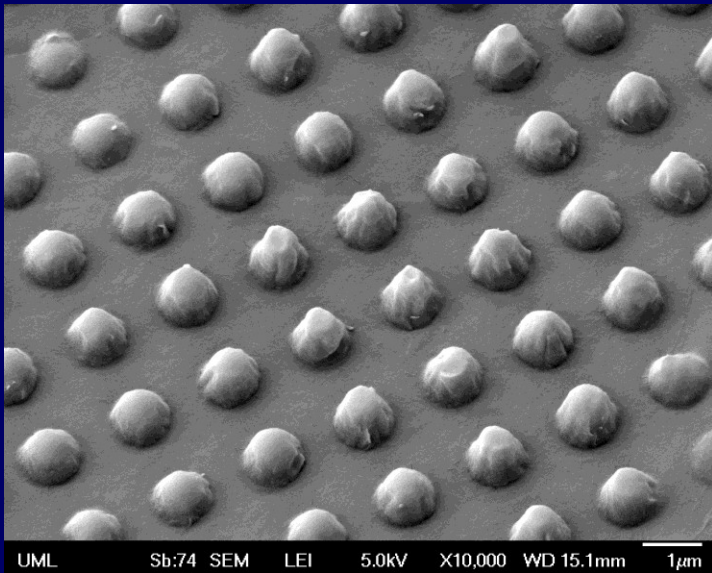
1. Gate location
2. Vacuum venting
3. Tooling features
4. Tooling materials
5. Gas assisted injection molding

1. Impact of Gate Location

Parallel flow



features

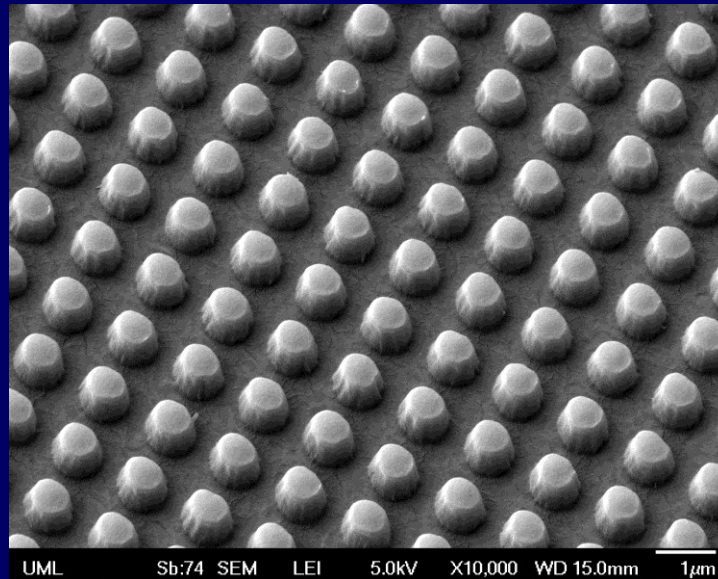


H ~ 1000 nm

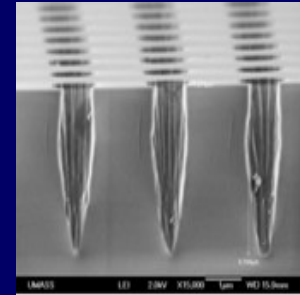
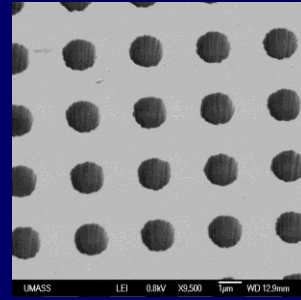
Impingement flow



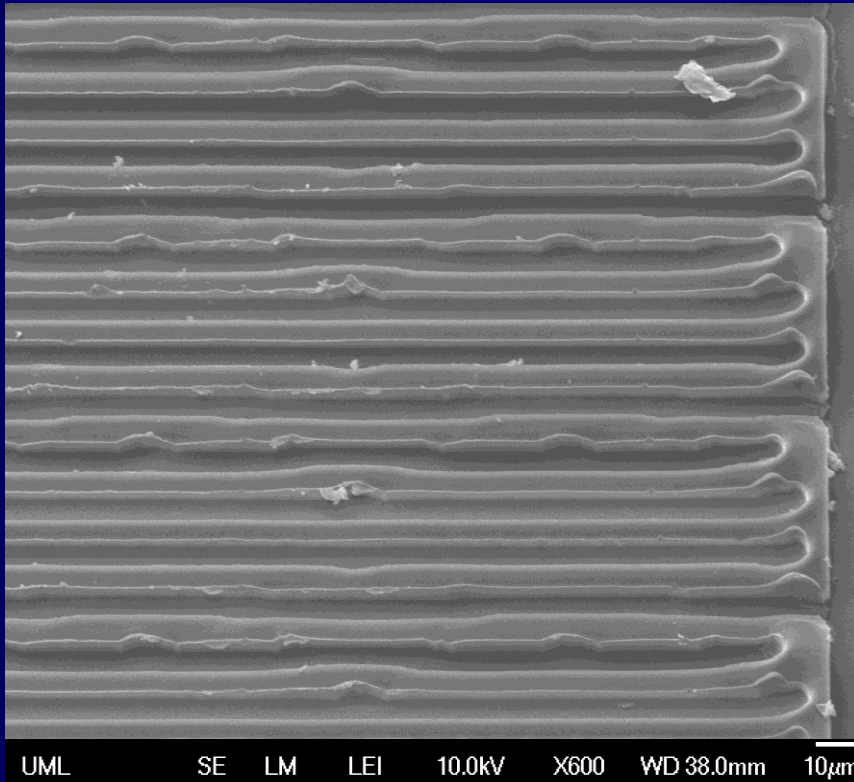
features



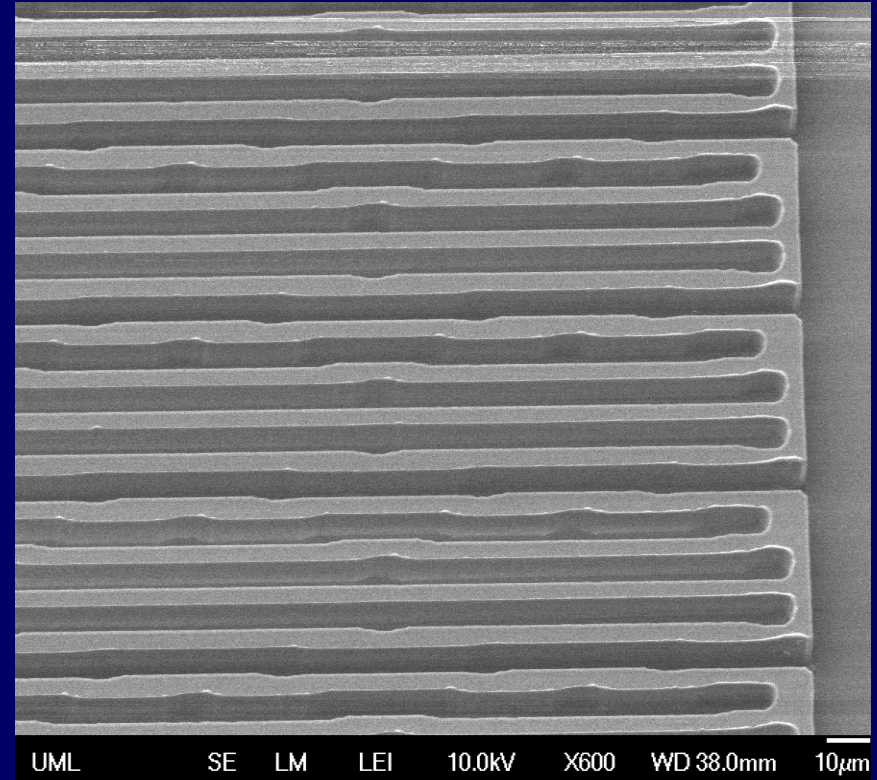
H ~ 400 nm



2. Effect of Vacuum Venting



Channels without vacuum

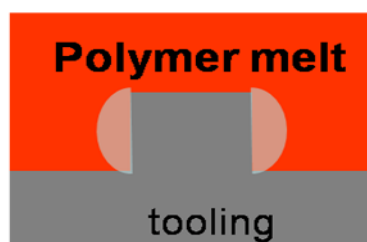


Channels with vacuum

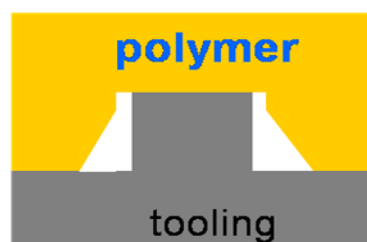
Better corner replication with vacuum venting

3. Tooling Features

Positive features



Filling

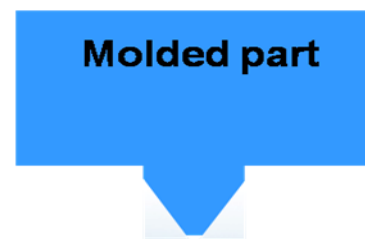
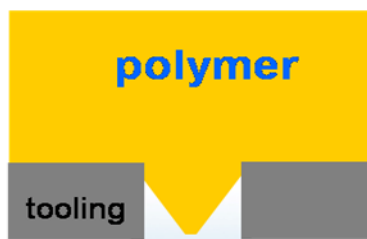


Cooling



Ejection

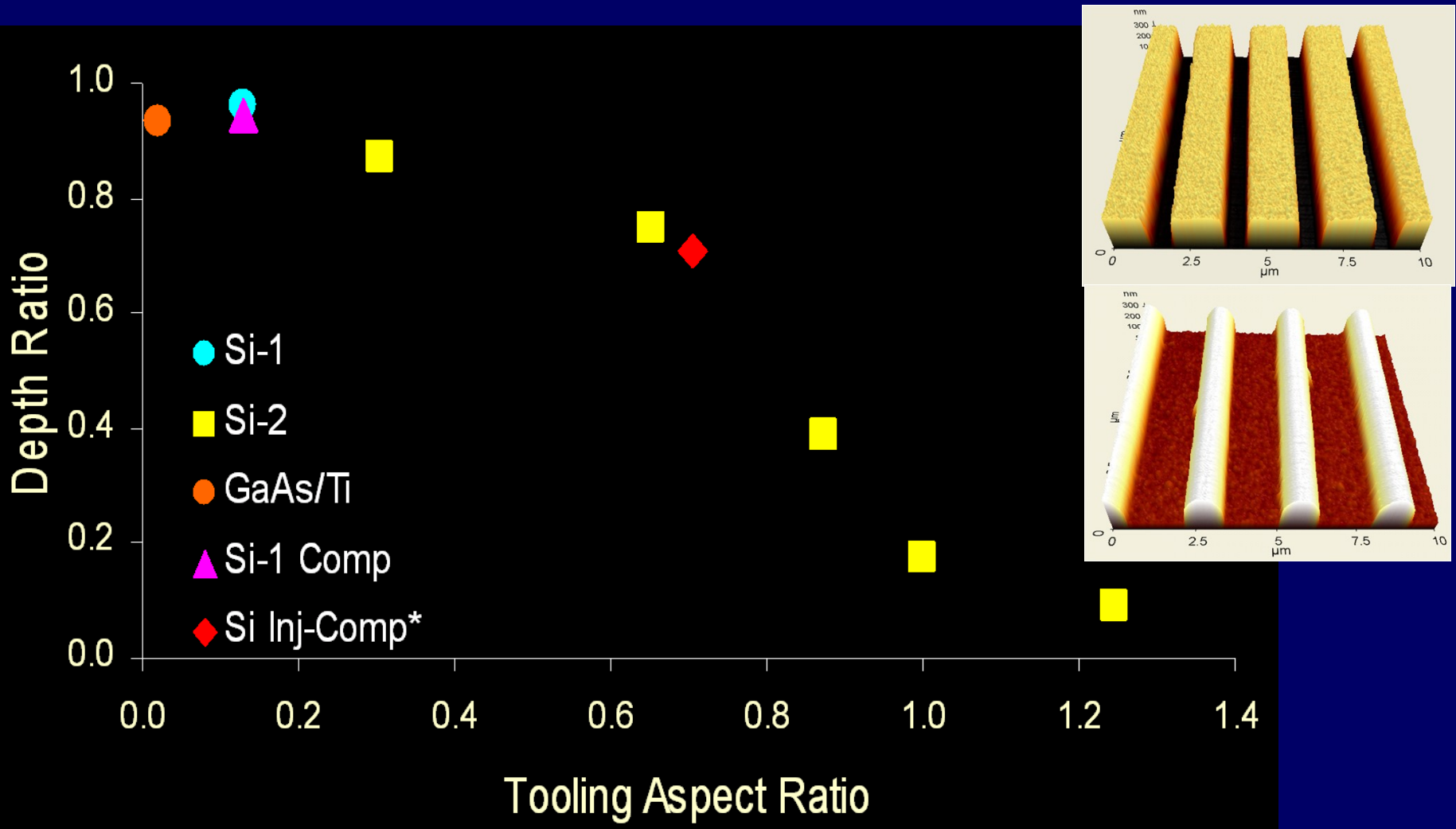
Negative features



| Thermoplastic Elastomer | DR | |
|----------------------------|----------|----------|
| | Positive | Negative |
| COPE | 1.03 | 0.60 |
| TPU-45 | 0.87 | 0.67 |
| TPU-39 | 0.75 | 0.68 |

Poorer replication with negative features

Effect of Feature Size



Smaller features are more difficult to replicate

4. Materials for Tooling Inserts

| Method | Resolution | Aspect Ratio | Material |
|----------------------|-----------------------|---------------------------------------------|----------------|
| CNC machining | 100 μm | N/A | steel |
| Micro milling | 50 -100 μm | | |
| Micro wire EDM | 1 - 50 μm | | |
| Electroforming | $\sim 20 \text{ nm}$ | ~ 2.5 | nickel alloys |
| Lithography - UV | 157 nm | typically low, but up to 30 ¹ | silicon, glass |
| Lithography - EUV | 13 nm | | |
| Lithography - E-beam | < 10 nm | | |

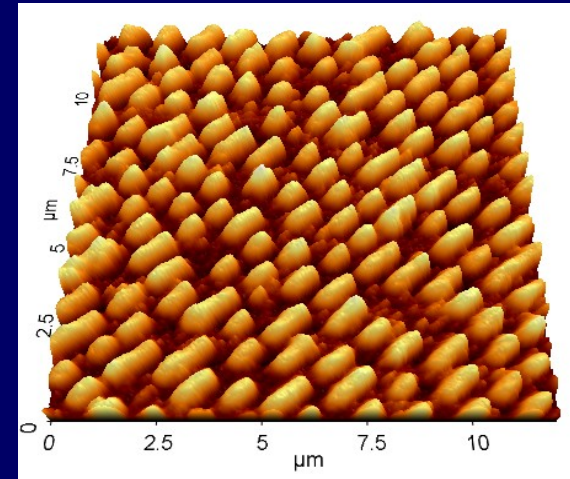
Created hybrid tooling for better feature replication

¹ RIE inductive coupled plasma source (http://www.oxfordplasma.de/process/sibo_ha.htm)

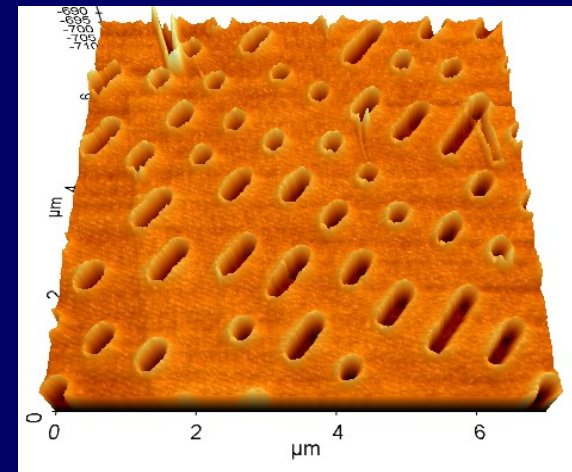
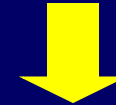
Molding with Nickel Tooling

- CD/DVD molding
 - Incomplete replication
 - Max. DR ~ 0.80 (PC)
- Molding with DVD tooling
 - Material-dependent replication

| Polymer | R_g , nm | DR |
|---------|------------|------|
| PMMA | 3.9 | 0.91 |
| PC | 6.5 | 0.80 |
| PS | 14 | 0.60 |

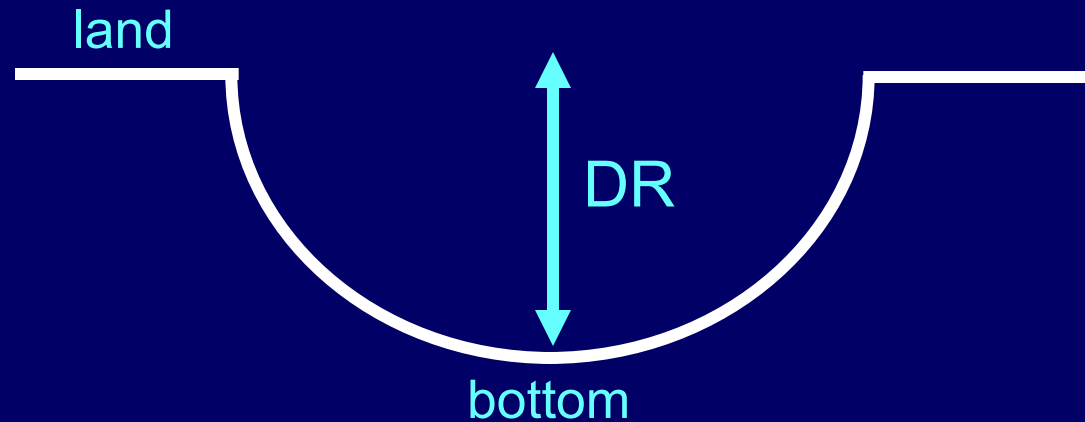
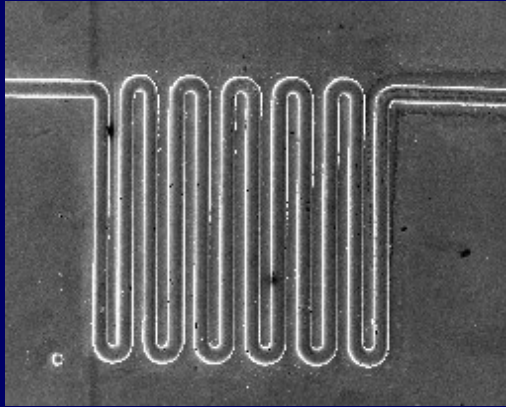


DVD tooling



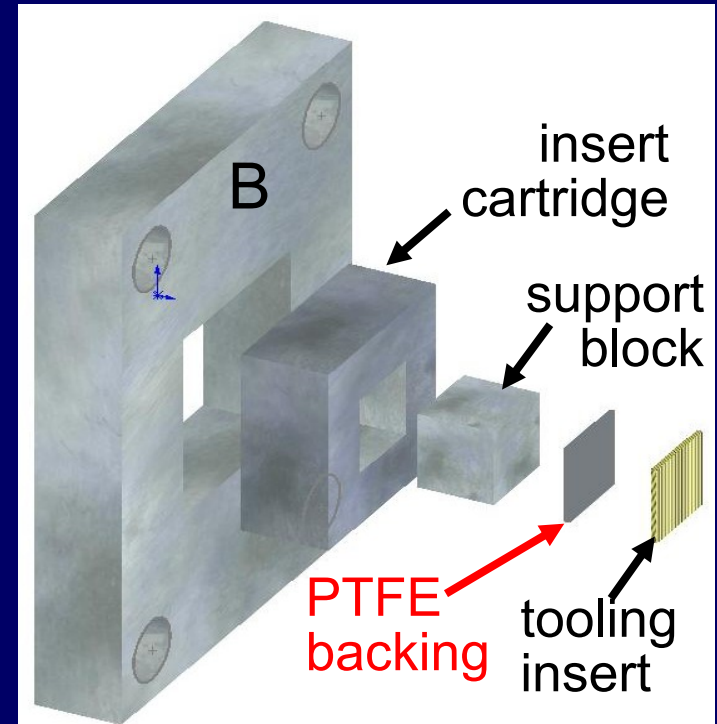
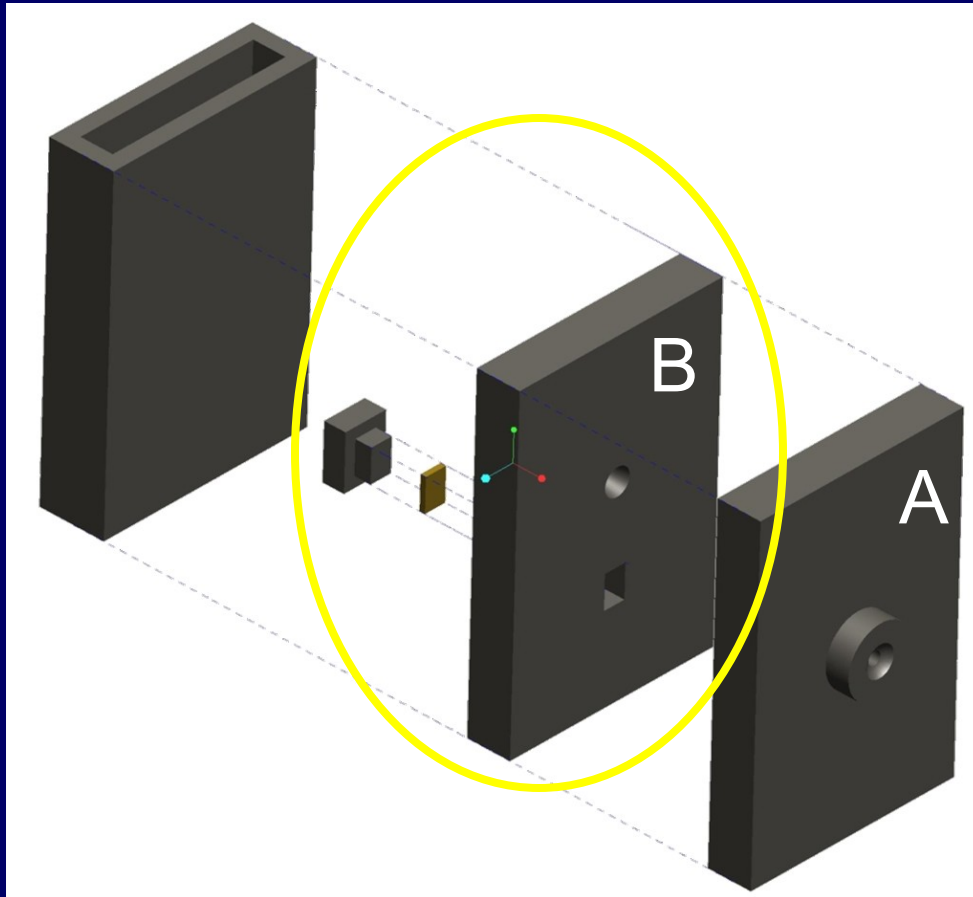
molded part

Factors Affecting Replication



- Replication of feature depth (i.e., DR) depends on material viscosity
- Replication of channel bottom depends on solidification time
- Replication of lands depends on achieving $DR = 100\%$

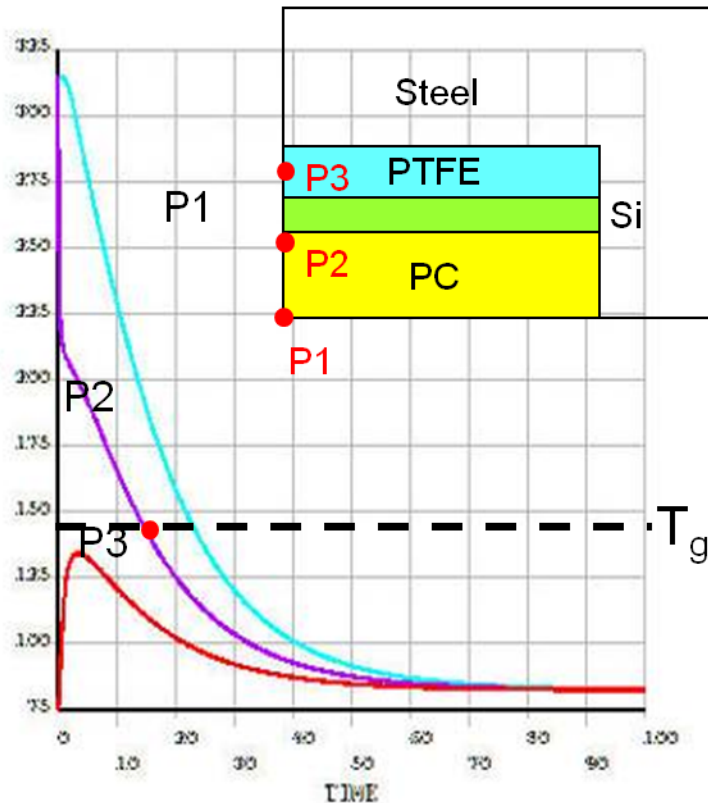
Molding with Silicon Wafers



PTFE prevented fracture of fragile tooling inserts → 3000 molding cycles

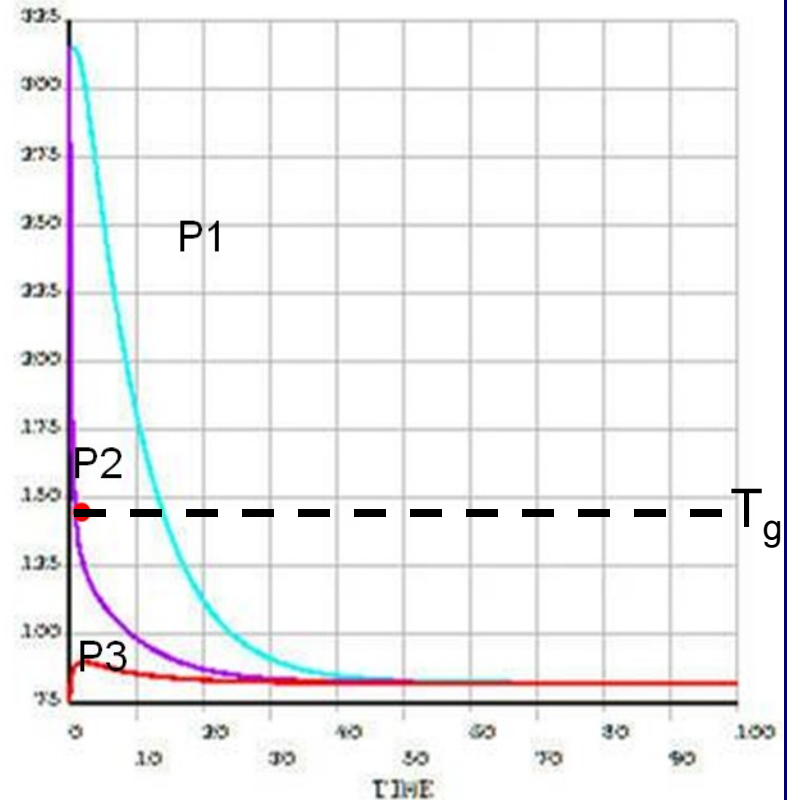
Effect of Backing Material

PTFE backing



Solidification time: 14 s

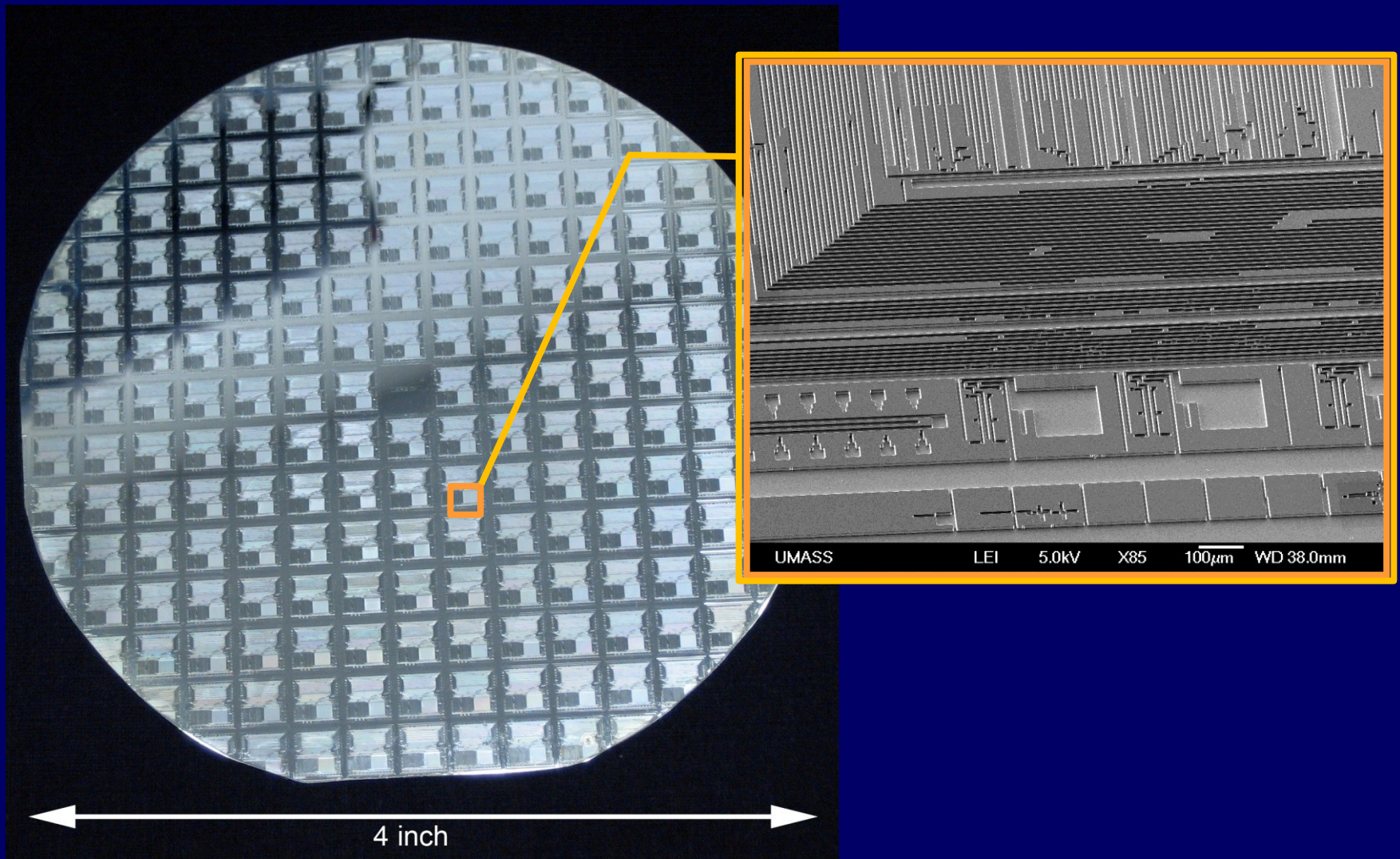
Cu backing



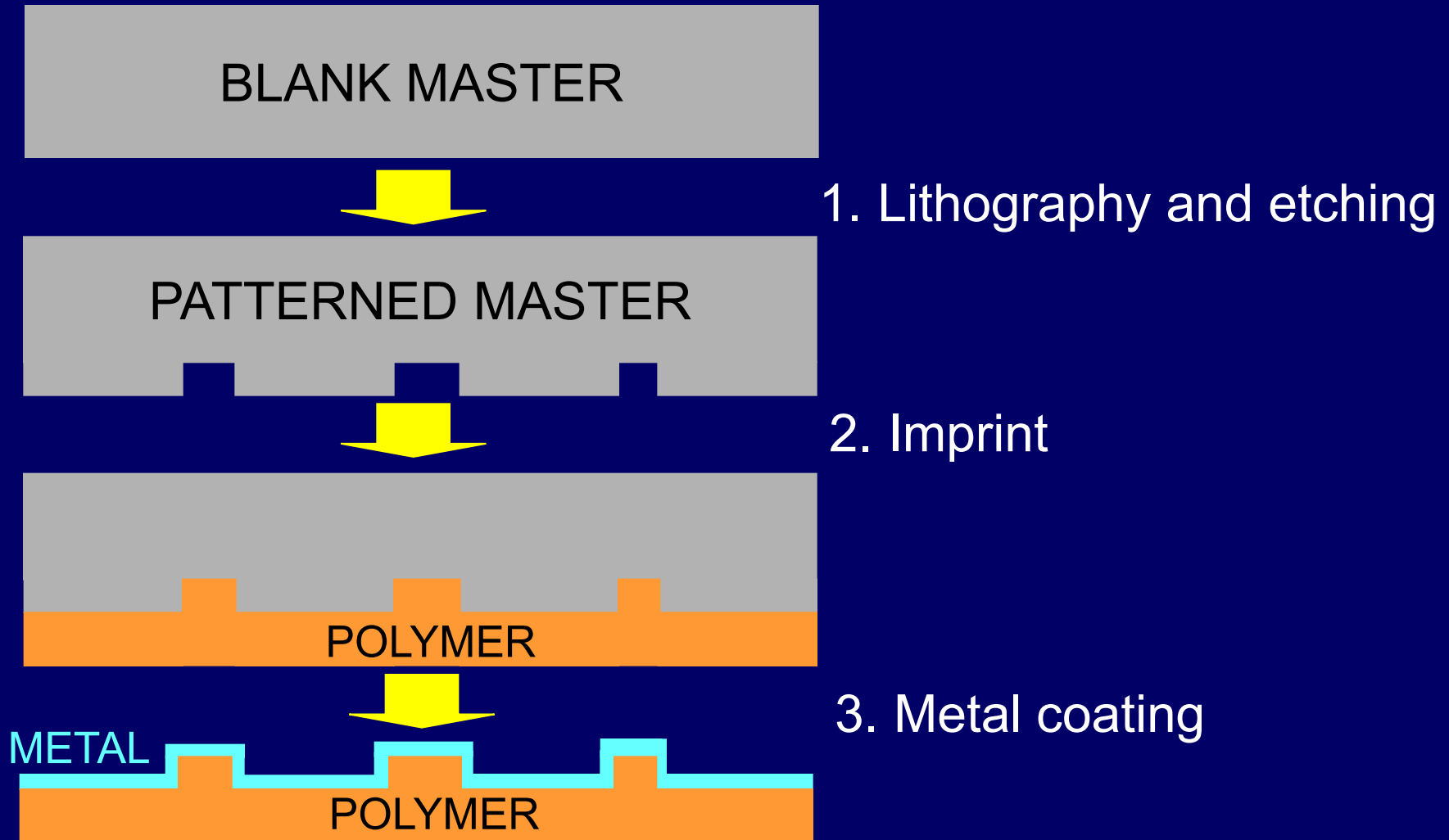
Solidification time: < 1 s

PTFE retarded heat transfer from silicon insert to steel mold

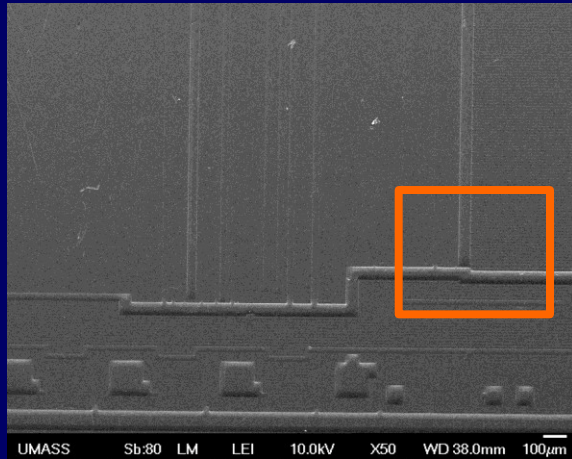
Molding with Hybrid Tooling



Fabrication of Hybrid Tooling

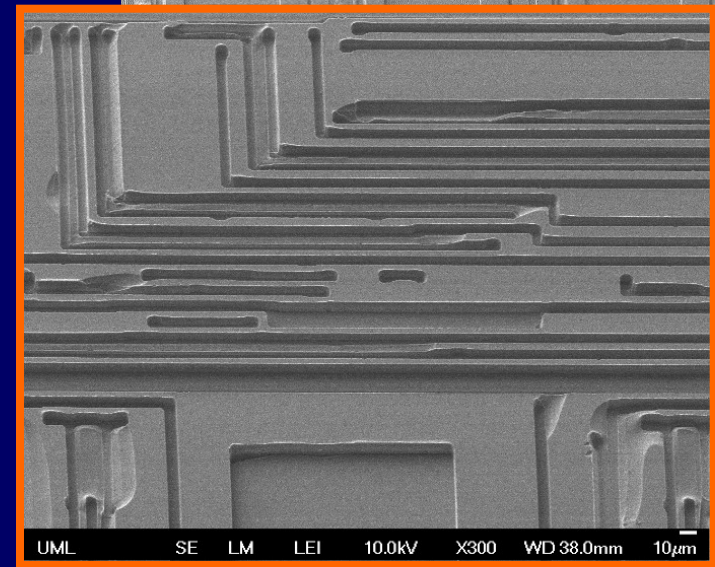
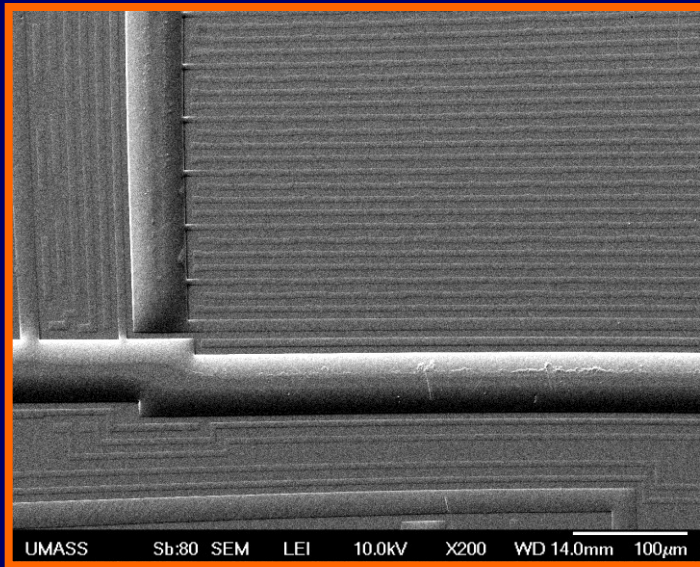
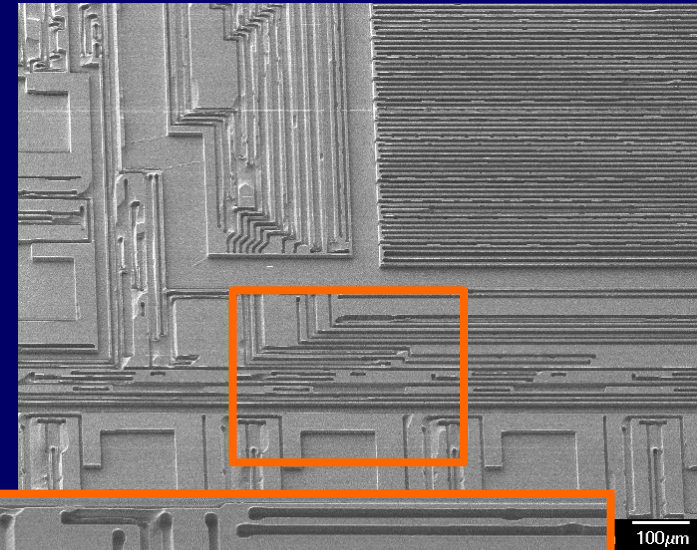


Feature Definition with Hybrid Tooling



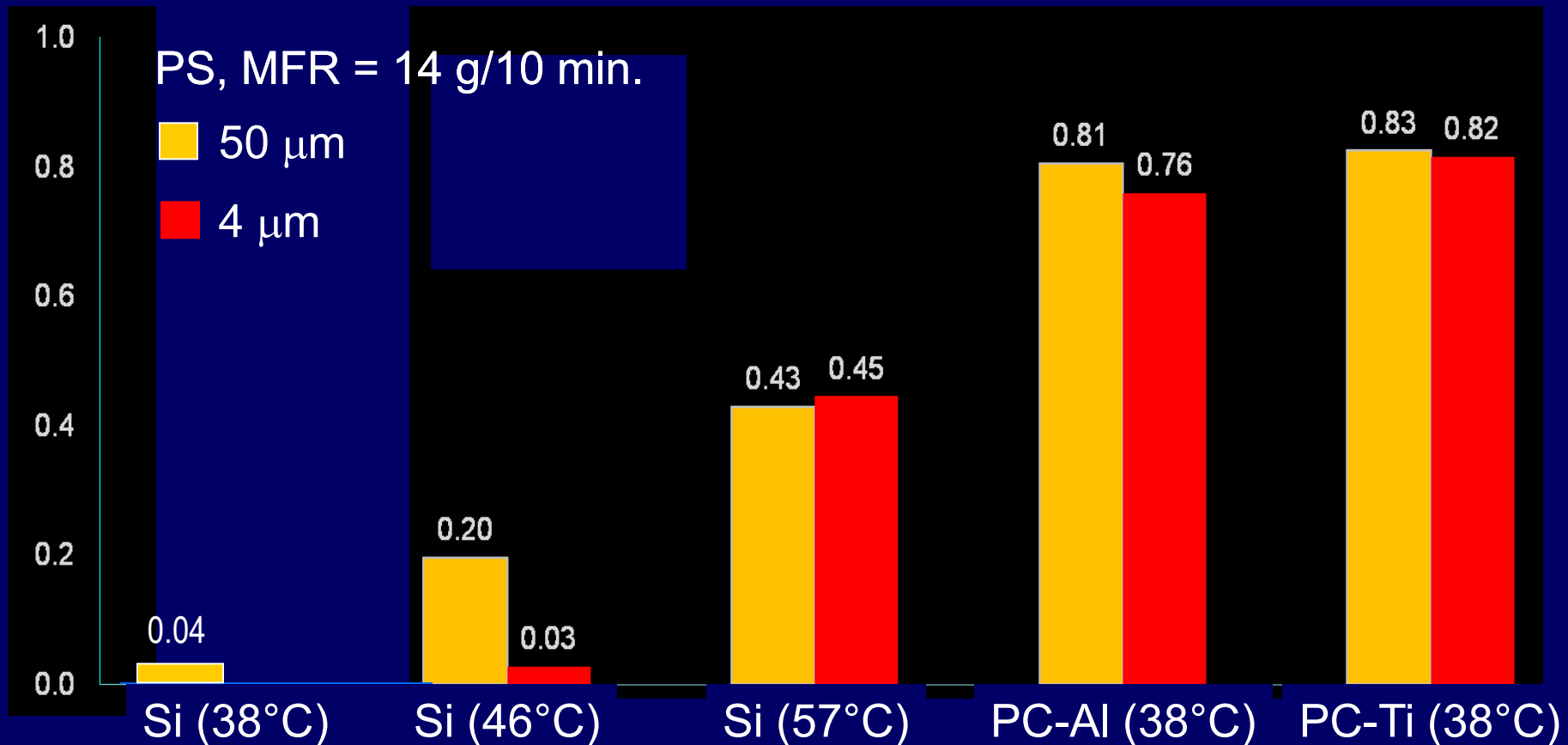
Si-FOTS

Al-PC



Depth Ratio with Hybrid Tooling

DR

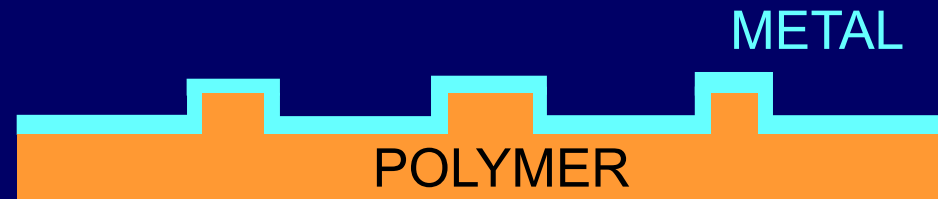


Hybrid tooling enhanced replication, but deformed during molding

New Polymer Layers

■ Candidate polymers

- Polyetherimide (T_g : 216°C)
- Polyimide (T_g : 350°C)
- Thermosets (Epoxy)



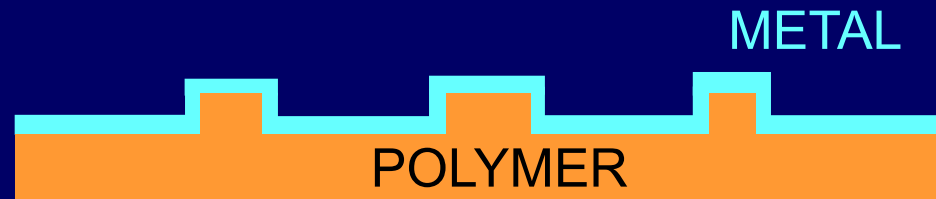
■ Performance of polymer layers

| Property | Units | PC | PI-1 | PI-2 |
|-------------|--------------------|------|------|------|
| Thickness | μm | 500 | 400 | 100 |
| T_g | $^{\circ}\text{C}$ | 151 | 369 | >400 |
| Performance | --- | Good | Good | Poor |

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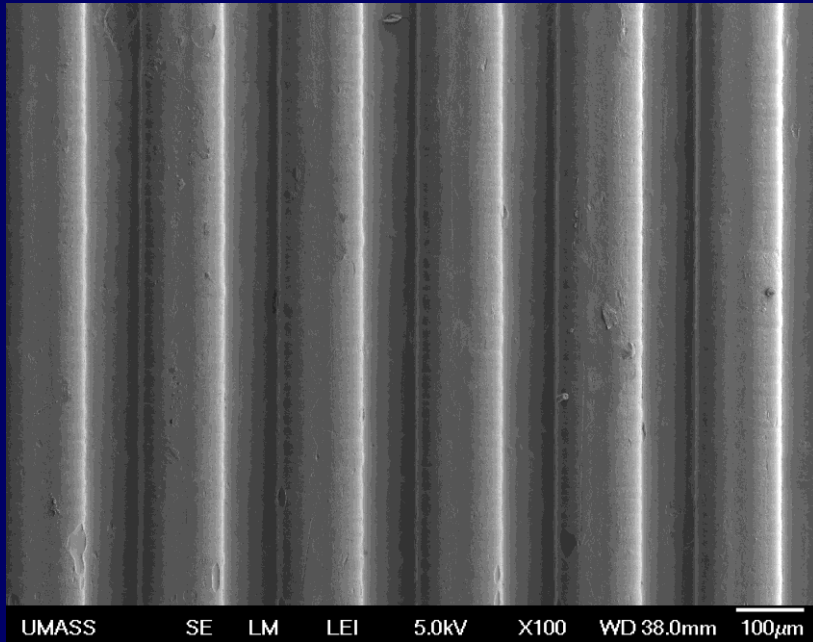


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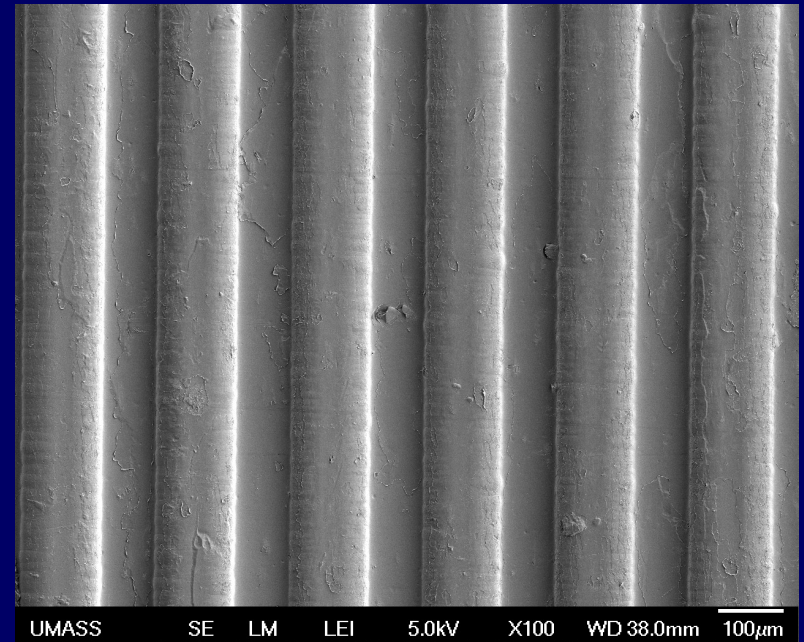
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PI-1 was better than PI-2 in transferring pattern

Parts Molded from PI Hybrid Tooling



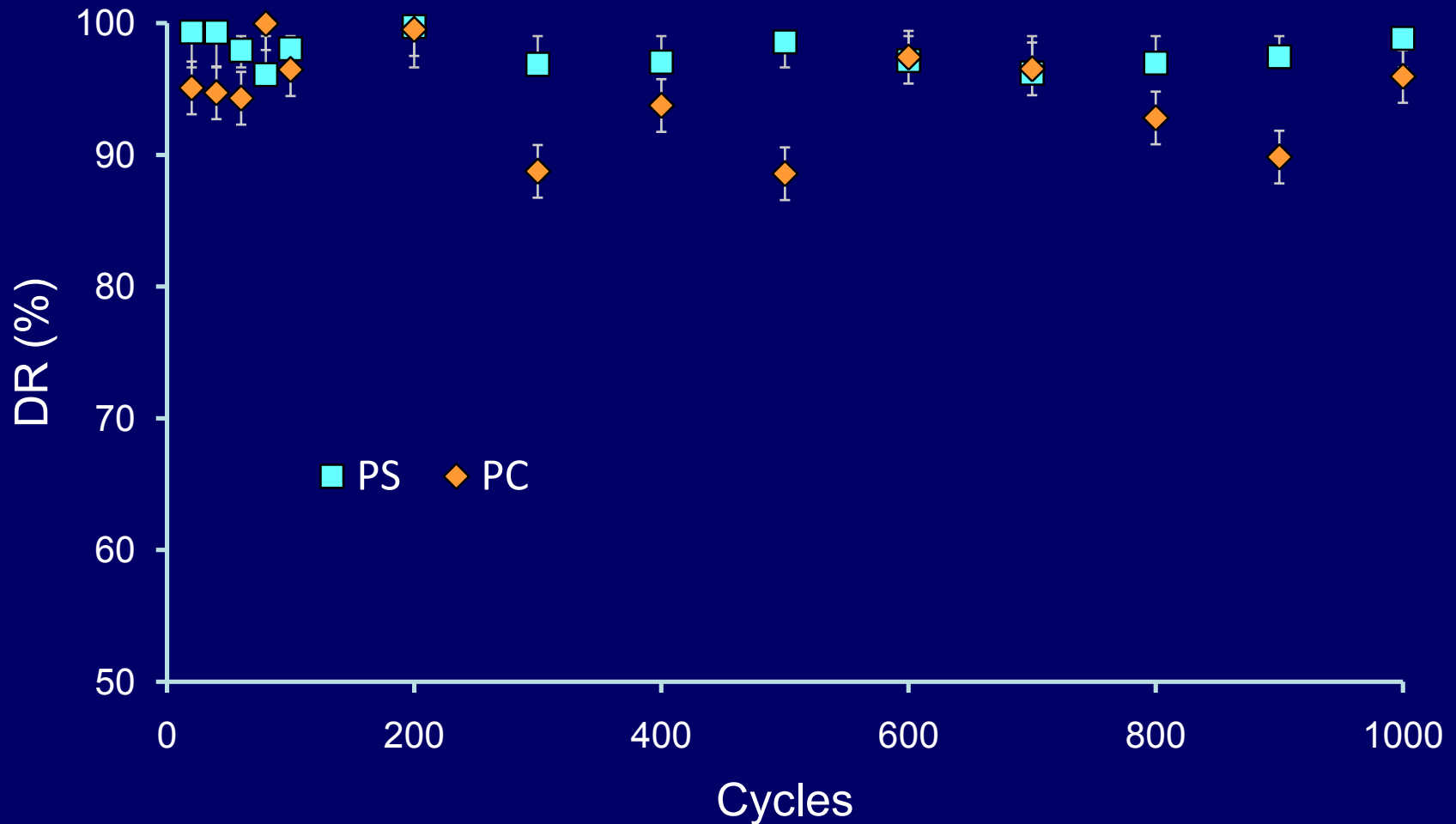
PS



PC

- Molded parts' surfaces were not damaged
- No loss in feature definition over 1000 cycles

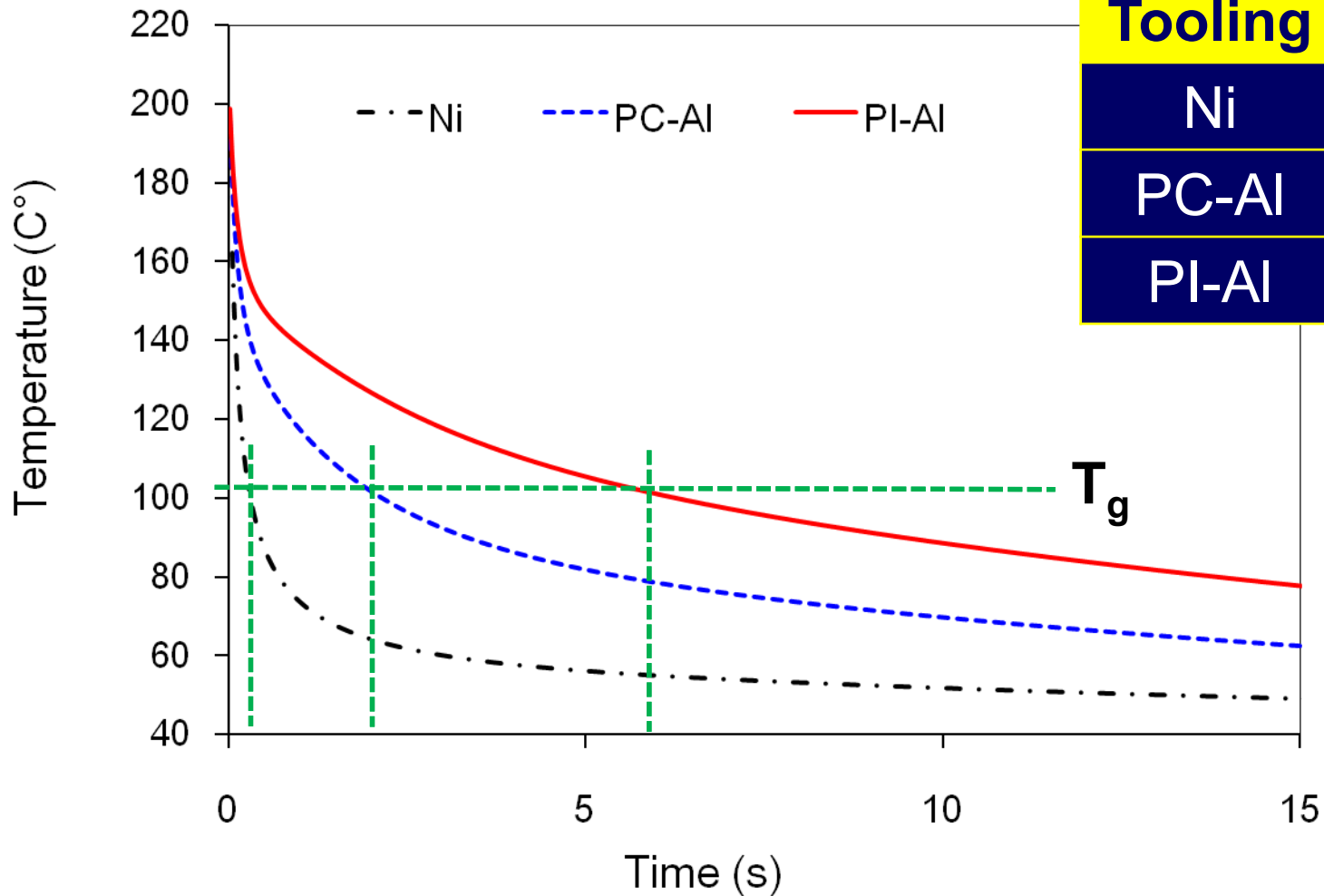
Effect of Molding Cycles on DR



PI-based tooling provided consistent DRs for 1000 molding cycles

Kim et al., *Proc. Ann. Tech. Conf. Soc. Plast. Eng.*, 2143 (2010)

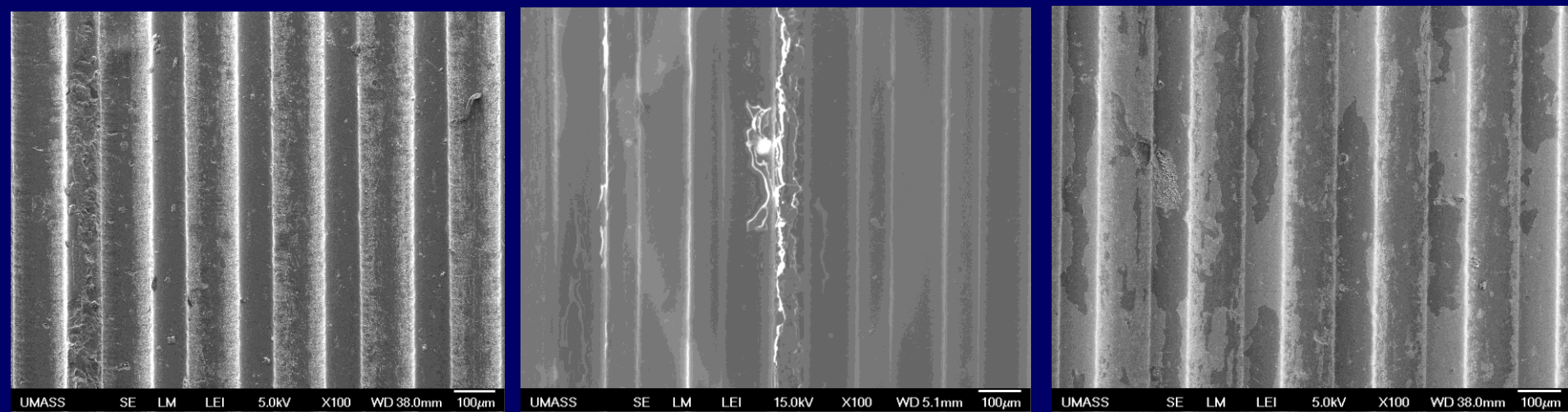
Temperature at the Tooling Surface



| Tooling | Time (s) |
|---------|----------|
| Ni | < 1 |
| PC-AI | ~ 2 |
| PI-AI | ~ 6 |

Slower cooling enhanced replication

Effect of Molding on Hybrid Tooling



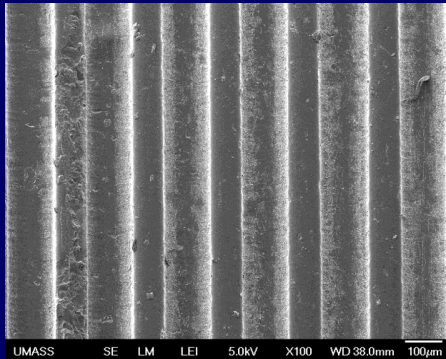
Before molding

After 1000 PS molding

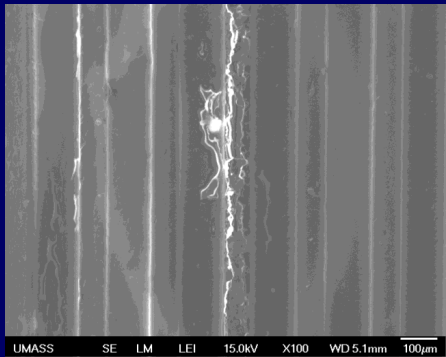
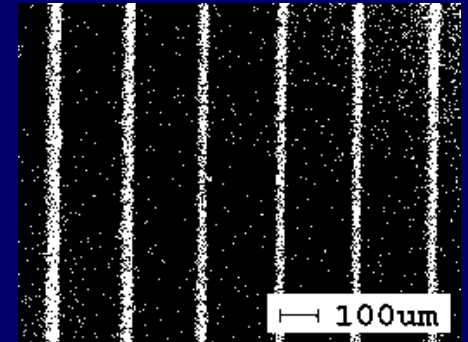
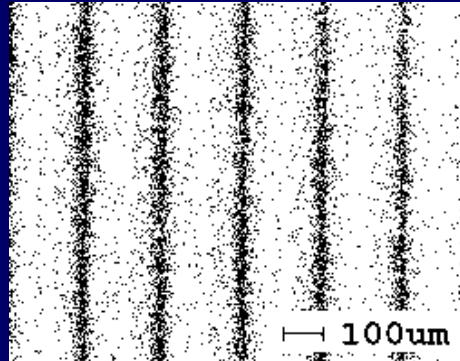
After 1000 PC molding

Tooling surface was not deformed, but showed defects

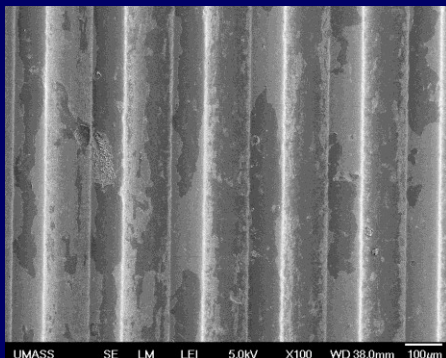
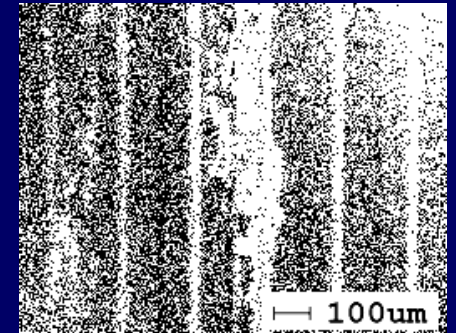
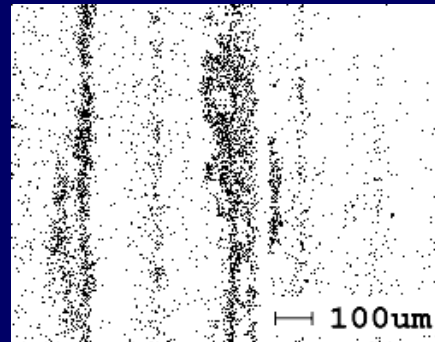
Analysis of Tooling Surface



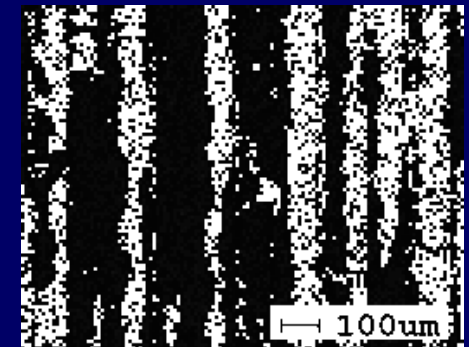
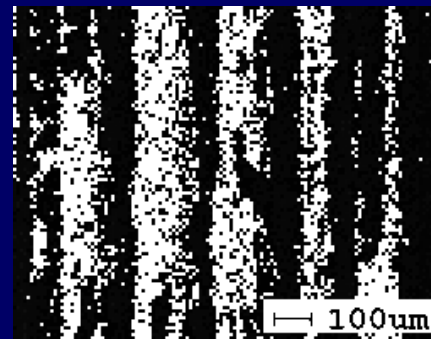
Before
molding



After 1000
PS molding



After 1000
PC molding

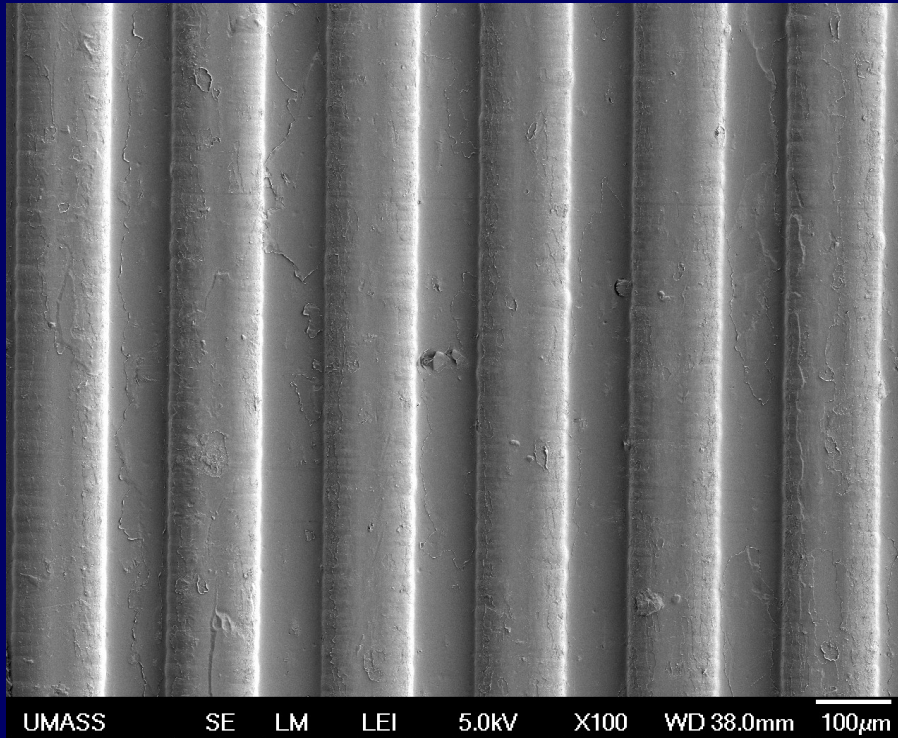


SEM

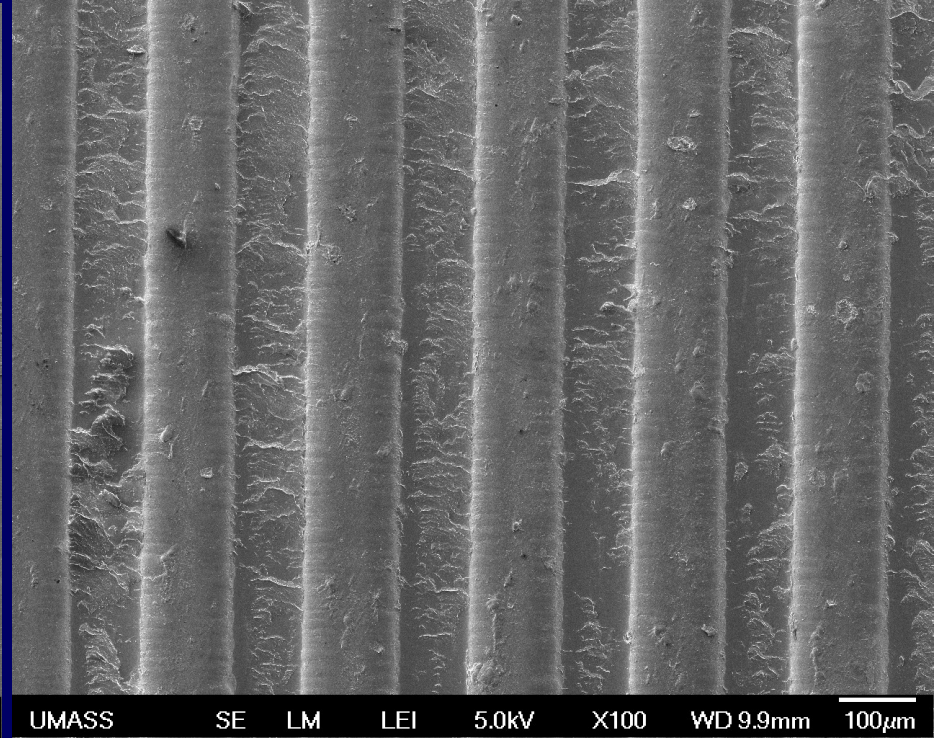
C

Al

Polymer Only Tooling?



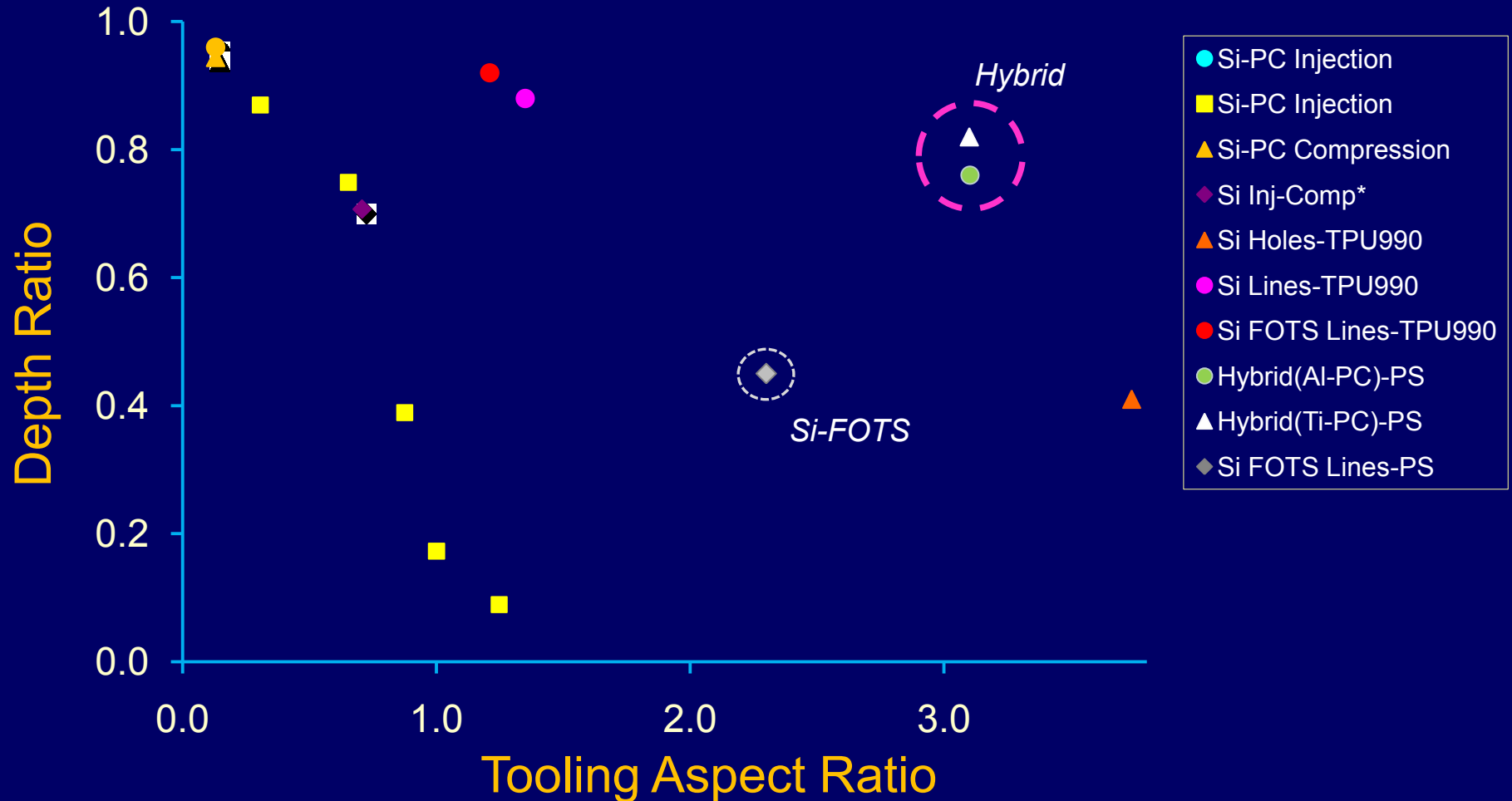
with PI-Al hybrid tooling
(after 1,000 cycles)



with PI "hybrid" tooling
(after 100 cycles)

Tooling without metal coating produced scaly surfaces

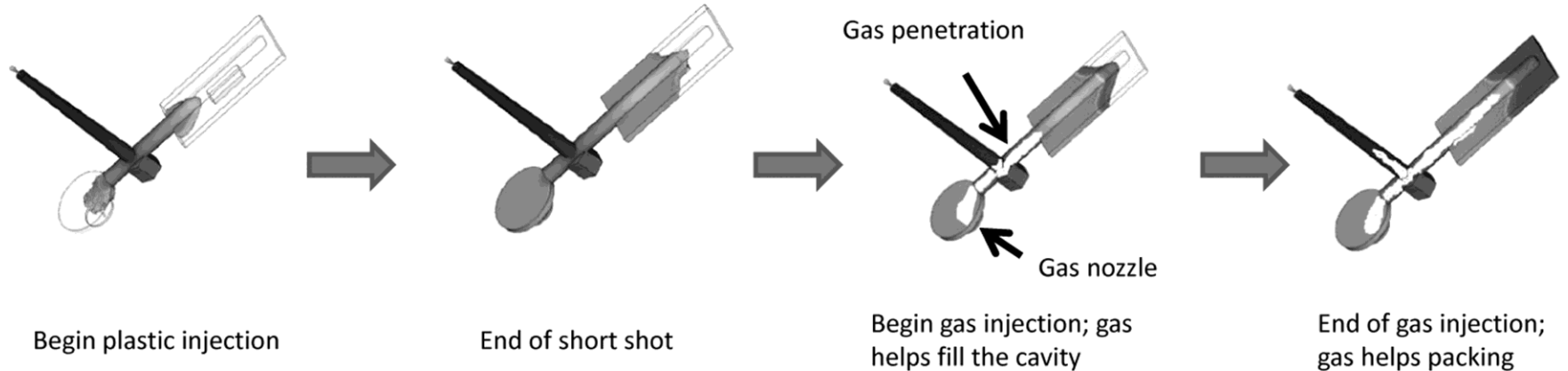
Comparison of Tooling Materials



5. Effect of Gas Assisted Injection Molding

▲ PP with gas ▲ PP without gas

▲ TPU with gas ▲ TPU without gas



0 0.0 0.5 1.0 1.5 2.0 2.5 3.0
AR

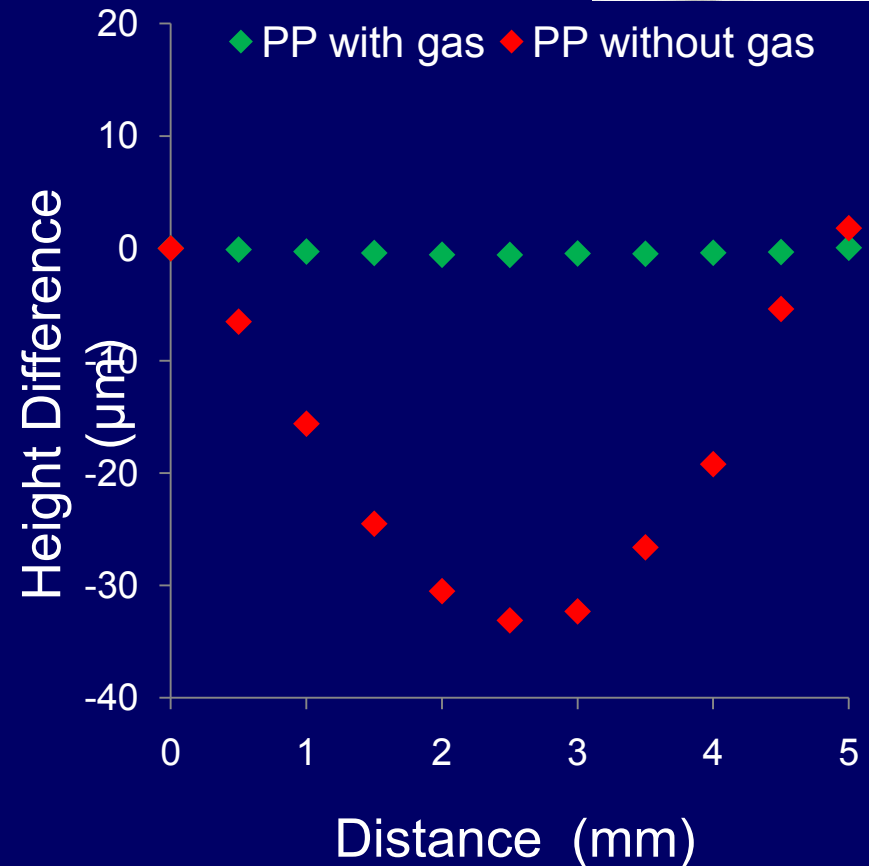
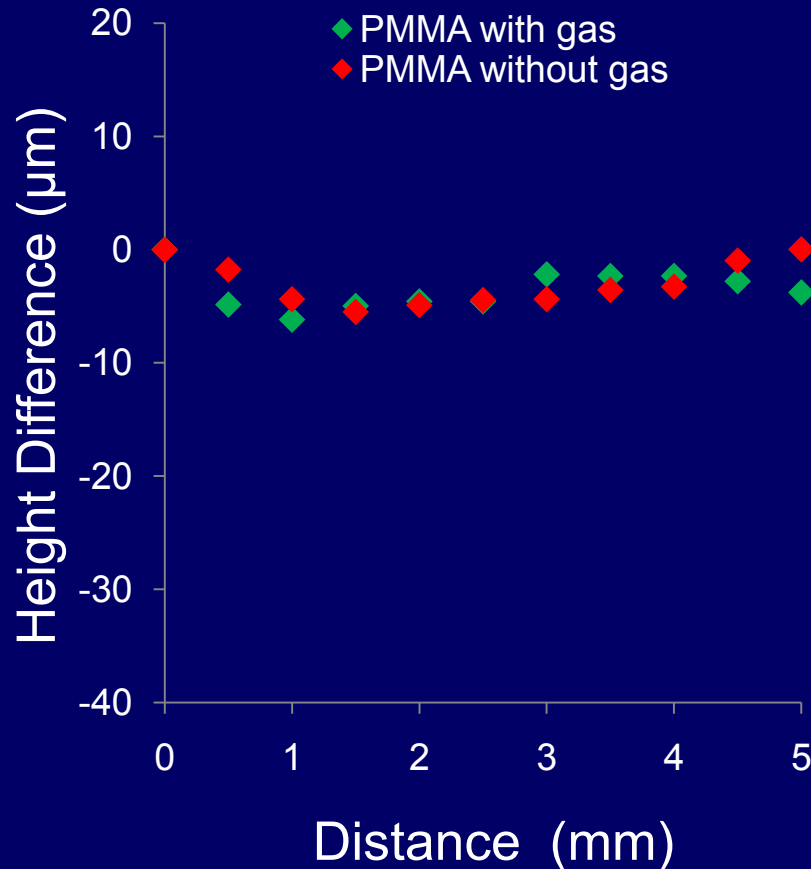
0 0.0 1.0 2.0 3.0
AR

GAIM improved depth ratio

Yoon et al., *Plastics, Rubber and Composites: Macromolecular Engineering*, accepted (2010)

Palanisamy et al., *Proc. Ann. Tech. Conf. Soc. Plast. Eng.*, 1316 (2009)

Effect of Gas Assisted Inj. Molding



GAIM eliminated sink marks in polypropylene parts

Yoon et al., *Plastics, Rubber and Composites: Macromolecular Engineering*, accepted (2010)

Palanisamy et al., *Proc. Ann. Tech. Conf. Soc. Plast. Eng.*, 1316 (2009)

Conclusions

- Gate location – often produces hesitation
- Vacuum venting – improves feature definition
- Tooling features
 - Positive features provide better replication than negative features
 - Smaller features are more difficult to replicate
- Tooling materials
 - Retarding heat transfer enhances replication
- Gas assisted injection molding
 - Improves replication, particularly with semi-crystalline polymers

Path Forward

- Effects of feature angles, radii, and size
- Impact of surface roughness
 - Silicon, steel



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